# ■ MN101C54A , MN101C54C

Туре	MN101C54A	MN101C54C				
ROM (x8-bit)	32 K	48 K				
RAM (×8-bit)	2 K	2 K				
Package	QFP084-P-1818E *Lead-free, LQFP080-P-1414A *Lead-free, TQFP080-P-1212D *Lead-free (under plan					
Minimum Instruction Execution Time	0.1 μs (at 4.5 V to 5.5 V, 20 MHz)  0.25 μs (at 2.7 V to 5.5 V, 8 MHz)*1  62.5 μs (at 2.0 V to 5.5 V, 32 kHz)*1.2  *1 The lower limit for operation guarantee for flash memory built-in type is 4.5 V.  *2 The lower limit for operation guarantee for EPROM built-in type is 2.3 V.					
Interrupts	• RESET • Watchdog • External 0 • External 1 • External 2 • External 3*1 • External 4 (key interrupt dedicated) • Timer 0 • Timer 1 • Timer 2 • Timer 3 • Timer 6 • Time base • Timer 7 (2 systems) • Timer 8 (2 systems) • Serial 0 (2 systems) • Serial 2 • A/D conversion finish *1 LQFP080-P-1414A,TQFP080-P-1212D: Not mounted					
Timer Counter	Timer counter 0: 8-bit × 1  (square-wave/8-bit PWM output, event count, generation of remote control carrier, simple pulse width measurement) (square-wave/PWM output to large current terminal P50 possible)  Clock source					
	Timer counter 1: 8-bit × 1 (square-wave output, event count, synchronous output event)  Clock source					
	Timer counter 0, 1 can be cascade-connected.					
	simple pulse width measurement) (square-wave/PV Clock source1/2, 1/4 of system	PWM output, event count, synchronous output event, WM output to large current terminal P52 possible) a clock frequency; 1/1, 1/4, 1/16, 1/32, 1/64 of OSC oscillation 1/1 of XI oscillation clock frequency; external clock input compare register 2				
	clock frequency; Interrupt source coincidence with	n clock frequency; 1/1, 1/4, 1/16, 1/64, 1/128 of OSC oscillati 1/1 of XI oscillation clock frequency; external clock input				
	Timer counter 2, 3 can be cascade-connected.					
	·	ck frequency; 1/1, 1/4096, 1/8192 of OSC oscillation clock /4096, 1/8192 of XI oscillation clock frequency compare register 6				
	output evevt, pulse width measurement, input cap possible)  Clock source	ycle / duty continuous variable), event count, synchronous pture) (square-wave/PWM output to large current terminal P: 6 of system clock frequency; 1/1, 1/2, 1/4, 1/16 of OSC frequency; 1/1, 1/2, 1/4, 1/16 of external clock input frequency compare register 7 (2 lines)				

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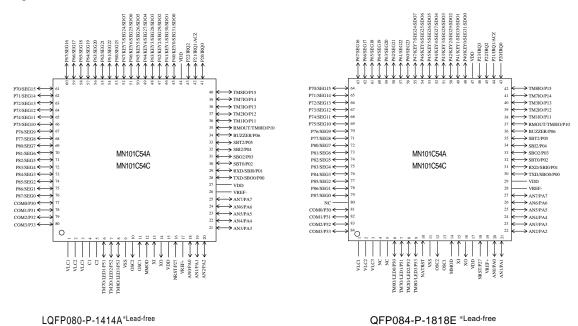
Timer Counter (Continue)		Timer counter 8: 16 bit × 1 (square-wave/16-bit PWM output [duty continuous variable], event count, pulse width measurement, input capture) (square-wave/PWM output to large current terminal P53 possible)  Clock source							
					Serial Interface		Serial 0 : synchronous type/UART (full-duplex) × 1  Clock source ····································		
							Seria	1 2 : synchronous type × 1 Clock source	• • •
I/O Pins	I/O	61 (60)	Common use	put/output selectable (bit unit) ( ): LQFP080-P-1414A,TQFP080-P-1212I					
	Input	4 (3)	Common use	( ): LQFP080-P-1414A,TQFP080-P-1212I					
A/D Inputs		10-b	it × 8-ch. (with S/H)						
LCD		LCD LCD	egments × 4 commons (static, 1/2, 1/3, or 1/4 duty) power supply separated from VDD (usable if VDD ≤ VLC power step-up circuit contained (3/2, 2 and 3 times) power shunt resistance contained	D ≤ 5.5 V)					
Special Ports	}	Buzzer output, remote control carrier signal output, high-current drive port							
Electrical Cha	aracteristics								

#### Electrical Characteristics

#### Supply current

Parameter	Symbol	Condition	Limit			Unit
Farameter	Symbol	Condition		typ	max	Oilit
	IDD1	fosc = 20 MHz, VDD = 5 V		25	60	mA
Operating supply current	IDD2	fosc = 8 MHz, VDD = 5 V		10	25	mA
	IDD3	fx = 32  kHz, VDD = 3  V		30	100	μА
Owner was a state	IDD4	fx = 32 kHz, VDD = 3 V, Ta = 25°C		4	8	μА
Supply current at HALT	IDD5	$fx = 32 \text{ kHz}, VDD = 3 \text{ V}, Ta = -40^{\circ}\text{C to } +85^{\circ}\text{C}$			30	μА
0 1	IDD6	VDD = 5 V, Ta = 25°C			2	μА
Supply current at STOP	IDD7	$VDD = 5 \text{ V}, \text{ Ta} = -40^{\circ}\text{C to} + 85^{\circ}\text{C}$			50	μА

### Pin Assignment



#### **Support Tool**

TQFP080-P-1212D \*Lead-free (under planning)

n-circuit Emulator	PX-ICE101C / D + PX-PRB101C54-TPFP080-P-1212D-M (under planning)           PX-ICE101C / D + PX-PRB101C54-QFP084-P-1818E-M           PX-ICE101C / D + PX-PRB101C54-LQFP080-P-1414A-M	
EPROM Built-in Type	Туре	MN101CP54C
	ROM (× 8-bit)	48 K
	RAM (× 8-bit)	2 K
	Minimum instruction execution time	0.1 μs (at 4.5 V to 5.5 V, 20 MHz)
		$0.25~\mu s$ (at $2.7~V$ to $5.5~V,~8~MHz)$
		62.5 µs (at 2.3 V to 5.5 V, 32 kHz)
	Package	LQFP080-P-1414A *Lead-free, QFP084-P-1818E *Lead-free,
		TQFP080-P-1212D *Lead-free (under planning)
Flash Memory Built-in Type	Туре	MN101CF54D [ES (Engineering Sample) available]
	ROM (× 8-bit)	64 K
	RAM (× 8-bit)	2 K
	Minimum instruction execution time	0.1 μs (at 4.5 V to 5.5 V, 20 MHz)
		$0.25~\mu s$ (at 4.5 V to 5.5 V, 8 MHz)
		62.5 µs (at 4.5 V to 5.5 V, 32 kHz)
	Package	LQFP080-P-1414A *Lead-free, QFP084-P-1818E *Lead-free,
		TQFP080-P-1212D *Lead-free (under planning)

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